

Vorläufige Daten Preliminary Data

Diode, D1 / D4 / Diode, D1 / D4

Höchstzulässige Werte / Maximum Rated Values

Periodische Spitzensperrspannung Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{RRM}	1200	V
Dauergleichstrom Continuous DC forward current		I_F	15	A
Periodischer Spitzenstrom Repetitive peak forward current	$t_P = 1\text{ ms}$	I_{FRM}	50	A
Grenzlastintegral I^2t - value	$V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$ $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$	I^2t	40,0 34,0	A^2s A^2s

Charakteristische Werte / Characteristic Values

		min.	typ.	max.	
Durchlassspannung Forward voltage	$I_F = 15\text{ A}, V_{GE} = 0\text{ V}$		1,75	2,15	V
	$T_{vj} = 25^{\circ}\text{C}$				
	$I_F = 15\text{ A}, V_{GE} = 0\text{ V}$		1,75		V
	$T_{vj} = 125^{\circ}\text{C}$				
Rückstromspitze Peak reverse recovery current	$I_F = 15\text{ A}, -di_F/dt = 1300\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$		36,0		A
	$V_R = 350\text{ V}$		38,0		A
	$V_{GE} = -15\text{ V}$		38,0		A
Sperrverzögerungsladung Recovered charge	$I_F = 15\text{ A}, -di_F/dt = 1300\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$		1,05		μC
	$V_R = 350\text{ V}$		2,10		μC
	$V_{GE} = -15\text{ V}$		2,40		μC
	$T_{vj} = 25^{\circ}\text{C}$				
Abschaltenergie pro Puls Reverse recovery energy	$I_F = 15\text{ A}, -di_F/dt = 1300\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$		0,40		mJ
	$V_R = 350\text{ V}$		0,66		mJ
	$V_{GE} = -15\text{ V}$		0,70		mJ
	$T_{vj} = 25^{\circ}\text{C}$				
Wärmewiderstand, Chip bis Kühlkörper Thermal resistance, junction to heatsink	pro Diode / per diode		2,35		K/W
Temperatur im Schaltbetrieb Temperature under switching conditions		$T_{vj\text{ op}}$	-40	150	$^{\circ}\text{C}$

IGBT, T2 / T3 / IGBT, T2 / T3

Höchstzulässige Werte / Maximum Rated Values

Kollektor-Emitter-Sperrspannung Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	650	V
Implementierter Kollektor-Strom Implemented collector current		I_{CN}	30	A
Kollektor-Dauergleichstrom Continuous DC collector current	$T_H = 100^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$	I_{CDC}	15	A
Periodischer Kollektor-Spitzenstrom Repetitive peak collector current	$t_p = 1\text{ ms}$	I_{CRM}	60	A
Gate-Emitter-Spitzenspannung Gate-emitter peak voltage		V_{GES}	+/-20	V

Charakteristische Werte / Characteristic Values

		min.	typ.	max.	
Kollektor-Emitter-Sättigungsspannung Collector-emitter saturation voltage	$I_C = 15\text{ A}$ $V_{GE} = 15\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	$V_{CE\text{ sat}}$	1,20 1,25 1,28	1,45 V V V
Gate-Schwellenspannung Gate threshold voltage	$I_C = 0,30\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$		V_{GETH}	4,95 5,80 6,45	V
Gateladung Gate charge	$V_{GE} = -15 / 15\text{ V}$		Q_G	0,30	μC
Interner Gatewiderstand Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$		R_{Gint}	0,0	Ω
Eingangskapazität Input capacitance	$f = 1000\text{ kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		C_{ies}	1,65	nF
Rückwirkungskapazität Reverse transfer capacitance	$f = 1000\text{ kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		C_{res}	0,051	nF
Kollektor-Emitter-Reststrom Collector-emitter cut-off current	$V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	I_{CES}		1,0 mA
Gate-Emitter-Reststrom Gate-emitter leakage current	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$		I_{GES}		100 nA
Einschaltverzögerungszeit, induktive Last Turn-on delay time, inductive load	$I_C = 15\text{ A}, V_{CE} = 350\text{ V}$ $V_{GE} = -15 / 15\text{ V}$ $R_{Gon} = 15\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_{don}	0,035 0,035 0,035	μs μs μs
Anstiegszeit, induktive Last Rise time, inductive load	$I_C = 15\text{ A}, V_{CE} = 350\text{ V}$ $V_{GE} = -15 / 15\text{ V}$ $R_{Gon} = 15\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_r	0,01 0,012 0,013	μs μs μs
Abschaltverzögerungszeit, induktive Last Turn-off delay time, inductive load	$I_C = 15\text{ A}, V_{CE} = 350\text{ V}$ $V_{GE} = -15 / 15\text{ V}$ $R_{Goff} = 15\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_{doff}	0,34 0,38 0,39	μs μs μs
Fallzeit, induktive Last Fall time, inductive load	$I_C = 15\text{ A}, V_{CE} = 350\text{ V}$ $V_{GE} = -15 / 15\text{ V}$ $R_{Goff} = 15\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	t_f	0,045 0,07 0,075	μs μs μs
Einschaltverlustenergie pro Puls Turn-on energy loss per pulse	$I_C = 15\text{ A}, V_{CE} = 350\text{ V}, L_{\sigma} = 40\text{ nH}$ $di/dt = 1300\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $V_{GE} = -15 / 15\text{ V}, R_{Gon} = 15\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	E_{on}	0,19 0,26 0,28	mJ mJ mJ
Abschaltverlustenergie pro Puls Turn-off energy loss per pulse	$I_C = 15\text{ A}, V_{CE} = 350\text{ V}, L_{\sigma} = 40\text{ nH}$ $du/dt = 2600\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $V_{GE} = -15 / 15\text{ V}, R_{Goff} = 15\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$	E_{off}	0,47 0,60 0,64	mJ mJ mJ
Kurzschlußverhalten SC data	$V_{GE} \leq 15\text{ V}, V_{CC} = 360\text{ V}$ $V_{CE\max} = V_{CES} - L_{SCE} \cdot di/dt$	$t_p \leq 8\ \mu\text{s}, T_{vj} = 25^{\circ}\text{C}$ $t_p \leq 6\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$	I_{SC}	210 150	A A
Wärmewiderstand, Chip bis Kühlkörper Thermal resistance, junction to heatsink	pro IGBT / per IGBT		R_{thJH}	1,75	K/W
Temperatur im Schaltbetrieb Temperature under switching conditions			$T_{vj\text{ op}}$	-40 150	$^{\circ}\text{C}$